

HAT2281C

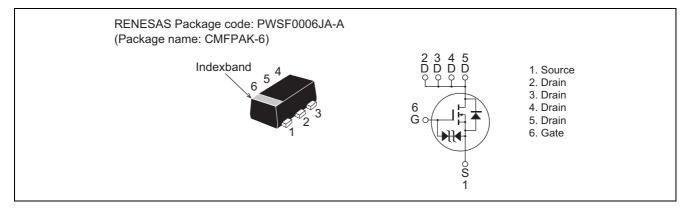
Silicon N Channel MOS FET Power Switching

> REJ03G1328-0200 Rev.2.00 Jan 26, 2006

Features

- Low on-resistance $R_{DS(on)} = 109 \text{ m}\Omega \text{ typ.}(at V_{GS} = 4.5 \text{ V})$
- Low drive current
- High density mounting
- 2.5 V gate drive device

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to Source voltage	V _{DSS}	60	V
Gate to Source voltage	V _{GSS}	±12	V
Drain current	ID	2	А
Drain peak current	I _{D (pulse)} Note1	8	А
Body - Drain diode reverse Drain current	I _{DR}	2	А
Channel dissipation	Pch Note2	850	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

2. When using the glass epoxy board (FR4 40 x 40 x 1.6mm)



Electrical Characteristics

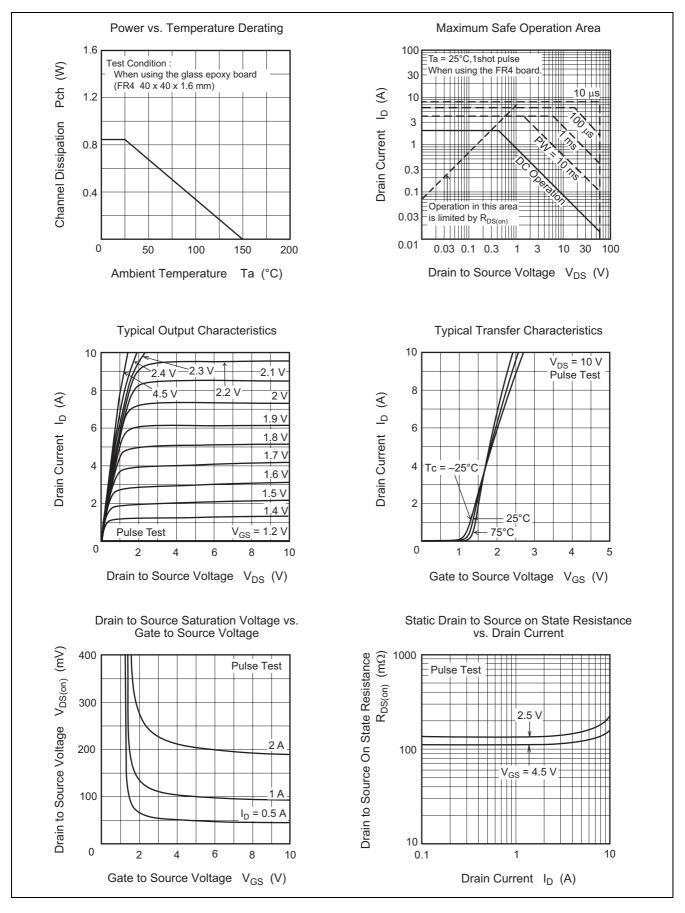
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						(Ta = 25°C)	
ltem	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to Source breakdown voltage	V _{(BR)DSS}	60	—		V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to Source breakdown voltage	V _{(BR)GSS}	±12				$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$	
Gate to Source leak current	I _{GSS}	_	—	±10	μΑ	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	
Drain to Source leak current	I _{DSS}	_	—	1	μΑ	$V_{DS} = 60 V, V_{GS} = 0$	
Gate to Source cutoff voltage	V _{GS(off)}	0.4	—	1.4	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	
Drain to Source on state resistance	R _{DS(on)}	_	109	142	mΩ	$I_D = 1.0 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note3}}$	
	R _{DS(on)}	_	126	177	mΩ	$I_D = 1.0 \text{ A}, V_{GS} = 2.5 \text{ V}^{\text{Note3}}$	
Forward transfer admittance	y _{fs}	3	4.5		S	$I_D = 1.0 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note3}}$	
Input capacitance	Ciss	_	335	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$	
Output capacitance	Coss	_	40	_	pF	f = 1 MHz	
Reverse transfer capacitance	Crss		20	_	pF		
Turn - on delay time	t _{d(on)}	_	12	_	ns	I _D = 1.0 A	
Rise time	tr	_	27	_	ns	$V_{GS} = 4.5 \text{ V}, V_{DD} = 10 \text{ V}$ $R_L = 10 \Omega, Rg = 4.7 \Omega$	
Turn - off delay time	t _{d(off)}	_	36	_	ns		
Fall time	t _f		5		ns		
Total Gate charge	Qg		3.6		nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	
Gate to Source charge	Qgs	_	0.6	_	nC	I _D = 2.0 A	
Gate to Drain charge	Qgd	_	0.7		nC		
Body - Drain diode forward voltage	V _{DF}		0.8	1.1	V	$I_F = 2.0 \text{ A}, V_{GS} = 0^{Note3}$	

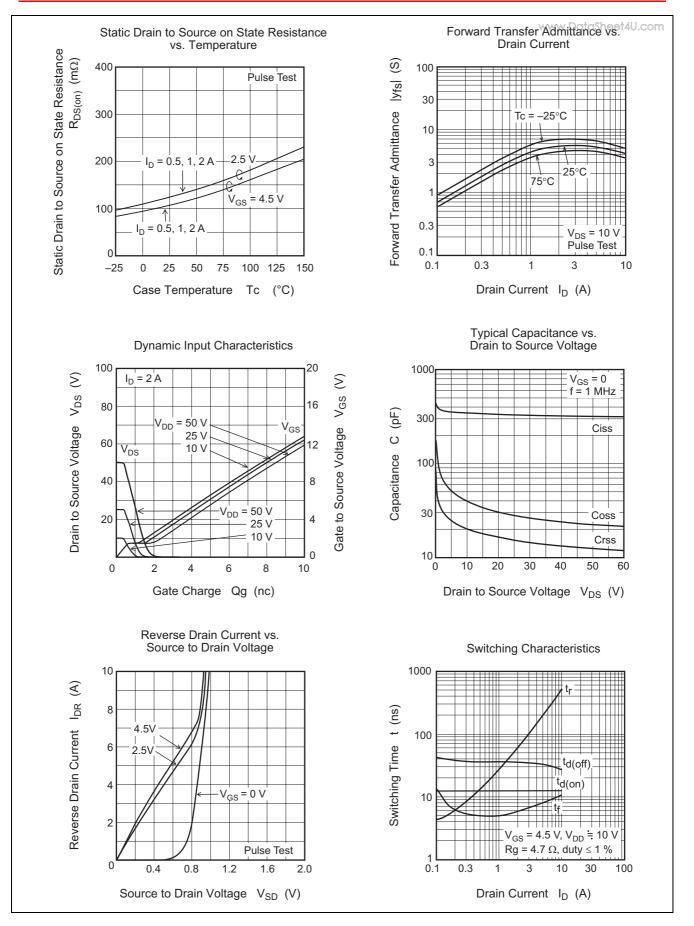
Notes: 3. Pulse test



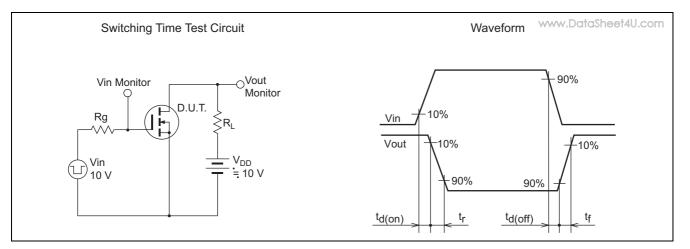
Main Characteristics







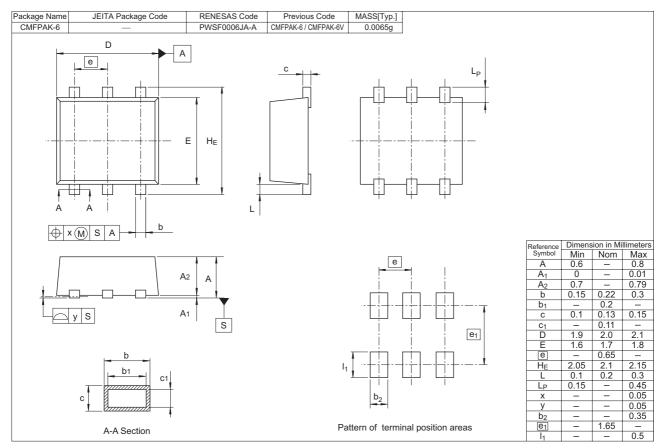






Package Dimensions

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Ordering Information

Part Name	Quantity	Shipping Container
HAT2281C-EL-E	3000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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